

Electronic Acknowledgement Receipt

EFS ID:	1445407
Application Number:	10798144
International Application Number:	
Confirmation Number:	5533
Title of Invention:	Method of depositing ALD thin films on wafer
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Filer Authorized By:	James J. Merrick
Attorney Docket Number:	YPL-0085
Receipt Date:	17-JAN-2007
Filing Date:	10-MAR-2004
Time Stamp:	17:12:02
Application Type:	Utility

Payment information:

Submitted with Payment	yes
Payment was successfully received in RAM	\$ 180
RAM confirmation Number	528
Deposit Account	061130

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1	Information Disclosure Statement (IDS) Filed	US_IDS_Form__SB_08a.pdf	719235	no	4
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